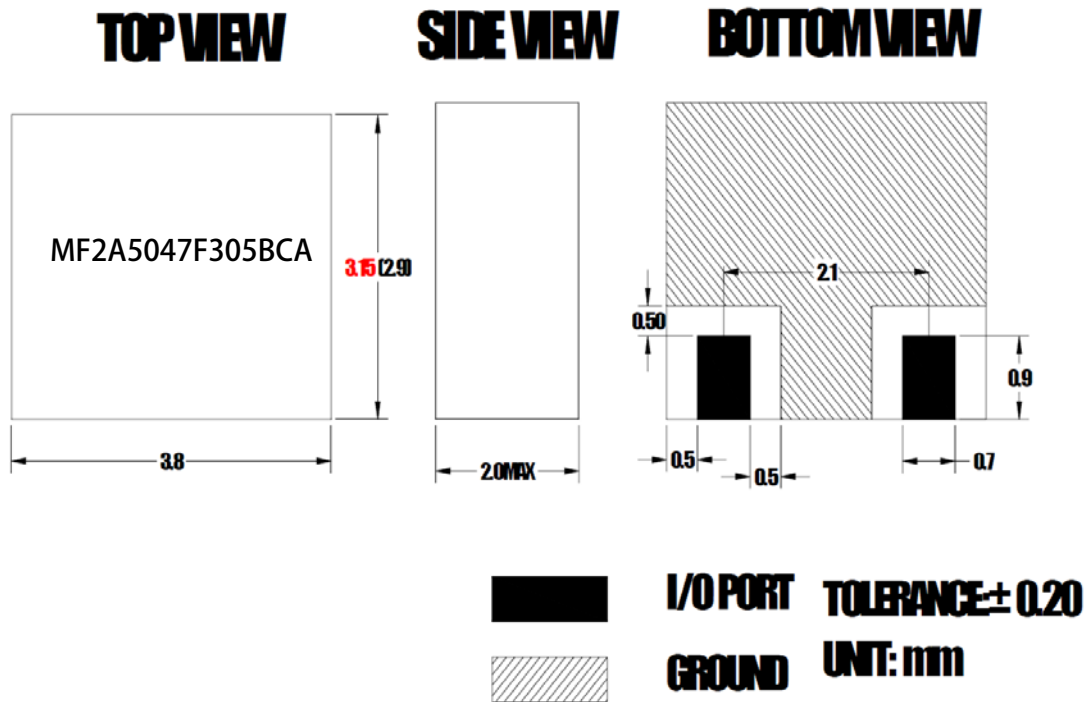


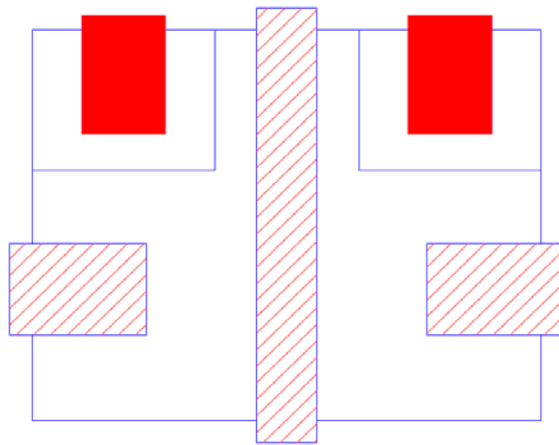
Electrical Specification

Parameter	Specification	Unit
Center Frequency	5047.5	MHz
Bandwidth (1dBBW)	$F_0 \pm 152.5 [4895 \sim 5200]$ min.	MHz
Insertion Loss in BW	2.0 max.	dB
VSWR in BW	2 :1 max.	Ratio
Attenuation (Absolute Value)	50 min.@0.1~1990 MHz	dB
	45 min.@2400~2484 MHz	
	30 min.@3200~3500 MHz	
	15 min.@6650~6850 MHz	
	20 min.@4435~4895 MHz	
	20 min.@5200~5820 MHz	
Impedance	50	ohm
Operating Temperature	-40 to +85	°C
Quantity	10	PCS

Outline Drawing



Recommended PCB Layout



 GROUND SOLDERING POINT

 IN/OUT PORT SOLDERING POINT

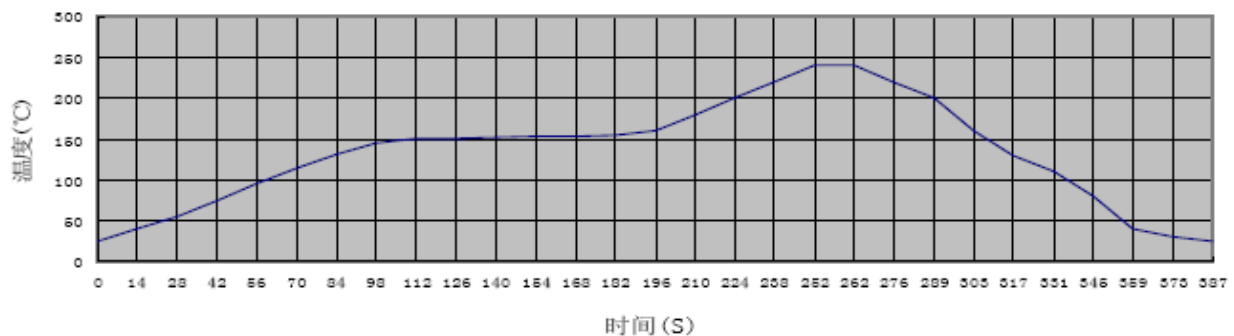
Remarks: Recommend to use silver-containing solder paste

Application Instructions:

1. Recommended Soldering Temperature

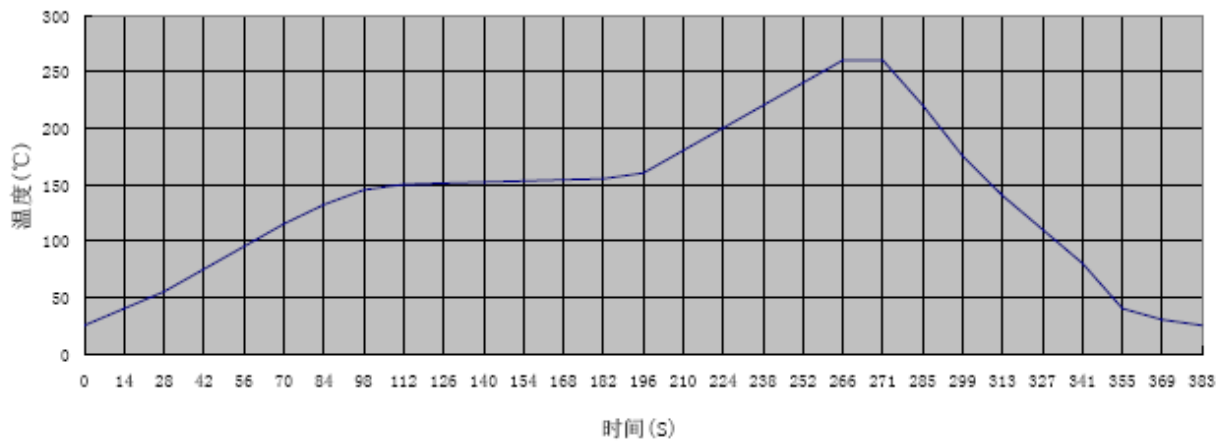
a. Containing Pb Soldering,

Recommend the solder paste of melting points 183°C, soldering temperature won't exceed 230°C. Refer to the below reflow soldering profile.

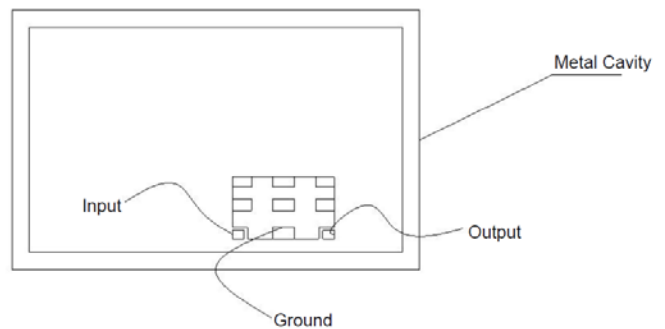
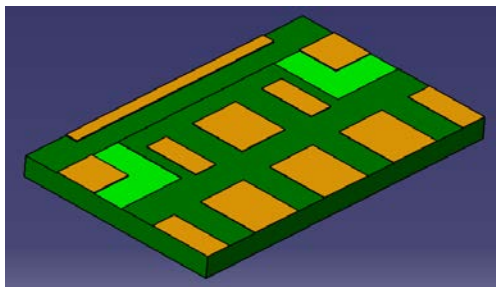


b. Pb-free soldering

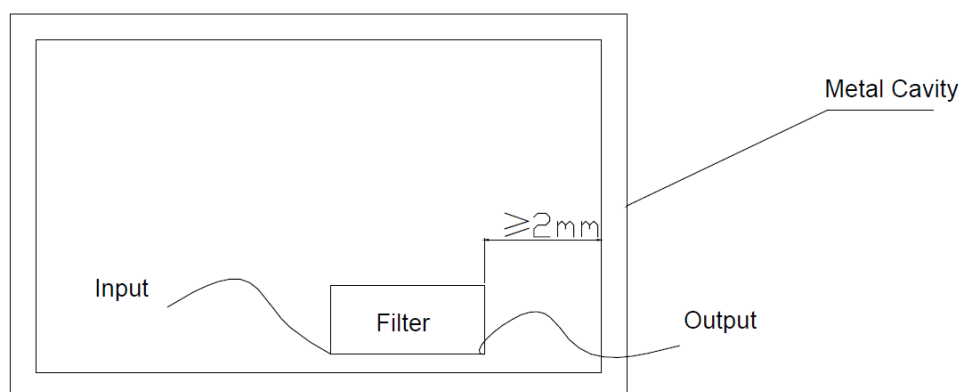
Recommend the solder paste of melting point 217°C, soldering temperature won't exceed 260°C. Refer to the below reflow soldering profile.



- PCB layout for soldering the filter should be designed in grid pattern. Refer to recommended PCB Layout for more details. Soldering Area is 50%-70% of ground area of this filter.



- This filter should be soldered 2mm (at least) away from metal cavity, in order to avoid degrading filter's performance by metal cavity. Refer to the below figure.



- It would achieve better performance that the top of the filter is grounded too.
- Mounting screws around the filter should be 1cm away from the filter.
- To avoid PCB transformation during mounting the filter.
- If customer will solder PCB of the filter on Aluminum plate, please contact us directly.